

Accepted Manuscript

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PII: S1359-4311(17)31288-7
DOI: <http://dx.doi.org/10.1016/j.applthermaleng.2017.07.183>
Reference: ATE 10851

To appear in: *Applied Thermal Engineering*

Received Date: 25 February 2017
Revised Date: 20 July 2017
Accepted Date: 25 July 2017

Please cite this article as: M. Yang, C. Li, Y. Zhang, Y. Wang, B. Li, D. Jia, Y. Hou, R. Li, Research on microscale skull grinding temperature field under different cooling conditions, *Applied Thermal Engineering* (2017), doi: <http://dx.doi.org/10.1016/j.applthermaleng.2017.07.183>

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Research on microscale skull grinding temperature field under different cooling conditions

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